



TP30-xxx Series

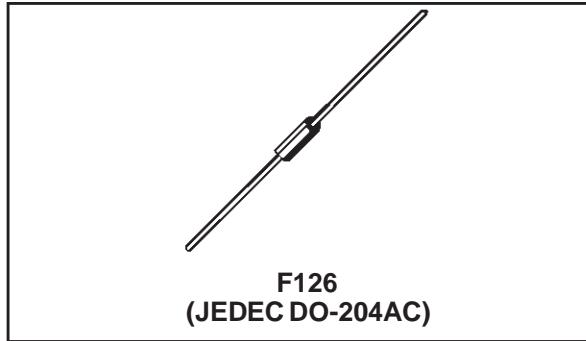
TRISIL™

FEATURES

- BIDIRECTIONAL CROWBAR PROTECTION.
- VOLTAGE RANGE: FROM 62 V TO 270 V.
- HOLDING CURRENT :
 $I_H = 150 \text{ mA min.}$
- REPETITIVE PEAK PULSE CURRENT :
 $I_{PP} = 30 \text{ A}, 10/1000 \mu\text{s.}$
- JEDEC REGISTERED PACKAGE OUTLINE

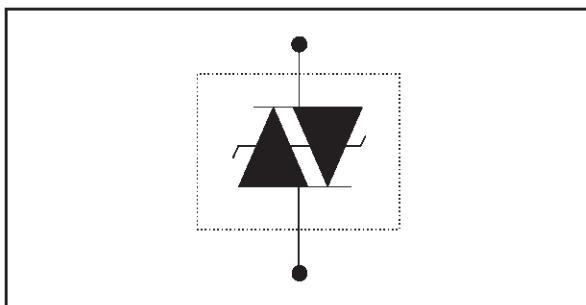
DESCRIPTION

The TP30-xxx series has been designed to protect telecommunication equipment against lightning surges and overvoltages induced by AC power lines.



F126
(JEDEC DO-204AC)

SCHEMATIC DIAGRAM



| COMPLIES WITH THE FOLLOWING STANDARDS: | Peak Surge Voltage (V) | Voltage Waveform (μs) | Current Waveform (μs) | Admissible I_{PP} (A) | Necessary Resistor (Ω) |
|--|------------------------|------------------------------------|------------------------------------|-------------------------|---------------------------------|
| (CCITT) ITU-K20 | 1000 | 10/700 | 5/310 | 25 | - |
| (CCITT) ITU-K17 | 1500 | 10/700 | 5/310 | 38 | - |
| VDE0433 | 2000 | 10/700 | 5/310 | 40 | 10 |
| VDE0878 | 2000 | 1.2/50 | 1/20 | 50 | - |
| IEC-1000-4-5 | level 2 level 3 | 10/700 1.2/50 | 5/310 8/20 | 25 50 | - |
| FCC Part 68, lightning surge type A | 1500 800 | 10/160 10/560 | 10/160 10/560 | 65 50 | 15.5 8.0 |
| FCC Part 68, lightning surge type B | 1000 | 9/720 | 5/320 | 25 | - |
| BELLCORE TR-NWT-001089 First level | 2500 1000 | 2/10 10/1000 | 2/10 10/1000 | 125 30 | 15.0 23.3 |
| BELLCORE TR-NWT-001089 Second level | 5000 | 2/10 | 2/10 | 125 | 15.0 |
| CNET I31-24 | 1000 | 0.5/700 | 0.8/310 | 25 | - |

TP30-xxx Series

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ C$)

| Symbol | Parameter | | Value | Unit |
|--------------------|---|---------------------------------|----------------------|-------------|
| P | Power dissipation on infinite heatsink | $T_{amb} = 50^\circ C$ | 3 | W |
| I_{PP} | Peak pulse current | 10/1000 μs 8/20 μs | 30 60 | A |
| I_{TSM} | Non repetitive surge peak on-state current | $t_p = 20$ ms | 15 | A |
| I^2t | I^2t value for fusing | $t_p = 20$ ms | 1 | A^2s |
| dV/dt | Critical rate of rise of off-state voltage | V_{RM} | 5 | kV/ μs |
| T_{stg} T_j | Storage temperature range Maximum junction temperature | | - 55 to + 150 150 | $^\circ C$ |
| T_L | Maximum lead temperature for soldering during 10s at 5mm for case | | 230 | $^\circ C$ |

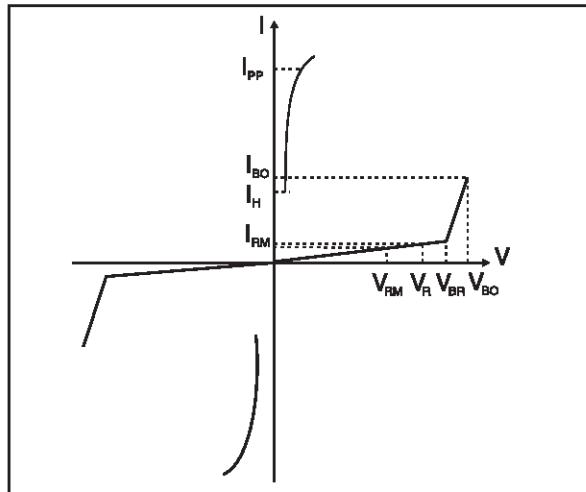
THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|----------------|---|-------|--------------|
| $R_{th} (j-l)$ | Junction to leads | 60 | $^\circ C/W$ |
| $R_{th} (j-a)$ | Junction to ambient on printed circuit with standard footprint dimension | 100 | $^\circ C/W$ |

ELECTRICAL CHARACTERISTICS

($T_{amb} = 25^\circ C$)

| Symbol | Parameter |
|----------|--------------------------------------|
| V_{RM} | Stand-off voltage |
| I_{RM} | Leakage current at stand-off voltage |
| V_R | Continuous Reverse voltage |
| V_{BR} | Breakdown voltage |
| V_{BO} | Breakover voltage |
| I_H | Holding current |
| I_{BO} | Breakover current |
| I_{PP} | Peak pulse current |
| C | Capacitance |



| Type | I _{RM} @ V _{RM} max | | I _R @ V _R max note 1 | | V _{BO} @ I _{BO} max note 2 | | I _H min note 3 | C typ note 4 | C typ note 5 |
|----------|--|-----|--|-----|--|-----|---------------------------------|--------------------|--------------------|
| | μA | V | μA | V | V | mA | | | |
| TP30-62 | 2 | 56 | 50 | 62 | 82 | 800 | 150 | 50 | 20 |
| TP30-68 | 2 | 61 | 50 | 68 | 90 | 800 | 150 | 50 | 20 |
| TP30-100 | 2 | 90 | 50 | 100 | 133 | 800 | 150 | 40 | 16 |
| TP30-120 | 2 | 108 | 50 | 120 | 160 | 800 | 150 | 40 | 16 |
| TP30-130 | 2 | 117 | 50 | 130 | 173 | 800 | 150 | 35 | 14 |
| TP30-180 | 2 | 162 | 50 | 180 | 240 | 800 | 150 | 35 | 14 |
| TP30-200 | 2 | 180 | 50 | 200 | 267 | 800 | 150 | 30 | 12 |
| TP30-220 | 2 | 198 | 50 | 220 | 293 | 800 | 150 | 30 | 12 |
| TP30-240 | 2 | 216 | 50 | 240 | 320 | 800 | 150 | 30 | 12 |
| TP30-270 | 2 | 243 | 50 | 270 | 360 | 800 | 150 | 30 | 12 |

Note 1: I_R measured at V_R guarantee V_{BRmin} ≥ V_R

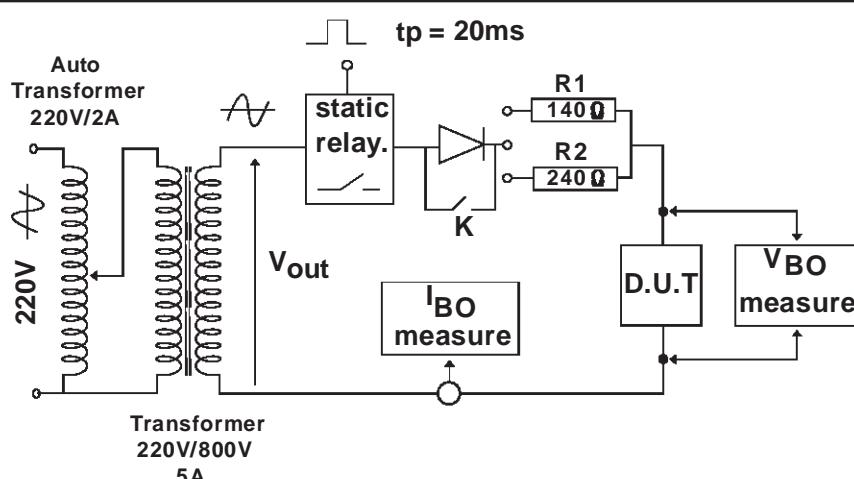
Note 2: Measured at 50 Hz (1 cycle) - See test circuit 1.

Note 3: See test circuit 2.

Note 4: V_R = 1V, F = 1MHz.

Note 5: V_R = 50V, F = 1MHz.

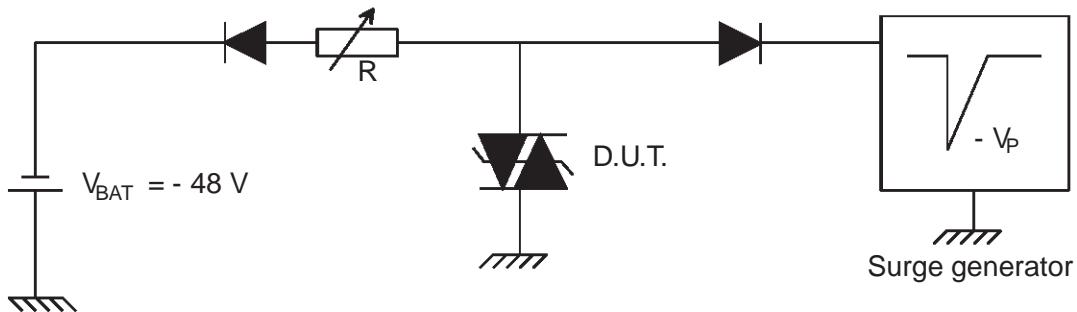
TEST CIRCUIT 1 FOR I_{BO} and V_{BO} parameters:



TEST PROCEDURE :

- Pulse Test duration (tp = 20ms):
 - For Bidirectional devices = Switch K is closed
 - For Unidirectional devices = Switch K is open.
- V_{OUT} Selection
 - Device with V_{BO} < 250 Volt
 - V_{OUT} = 250 V_{RMS}, R₁ = 140 Ω.
 - Device with V_{BO} ≥ 250 Volt
 - V_{OUT} = 480 V_{RMS}, R₂ = 240 Ω.

TEST CIRCUIT 2 for I_H parameter.



This is a GO-NOGO Test which allows to confirm the holding current (I_H) level in a functional test circuit.

TEST PROCEDURE :

- 1) Adjust the current level at the I_H value by short circuiting the AK of the D.U.T.
- 2) Fire the D.U.T with a surge Current : $I_{PP} = 10\text{ A}$, $10/1000\text{ }\mu\text{s}$.
- 3) The D.U.T will come back off-state within 50 ms max.

Fig. 1: Non repetitive surge peak on-state current versus overload duration (T_j initial = 25°C).

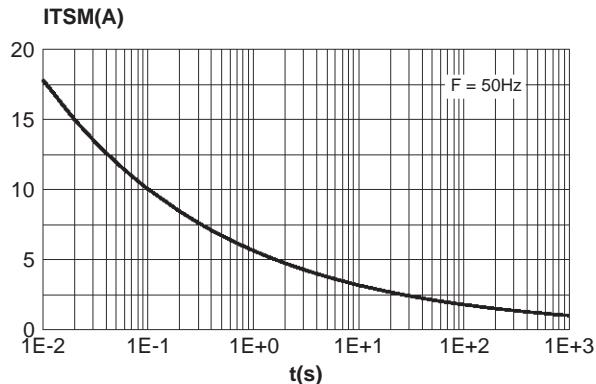


Fig. 3: Relative variation of junction capacitance versus reverse applied voltage (typical values).

Note: For VRM upper than 56V, the curve is extrapolated (dotted line)

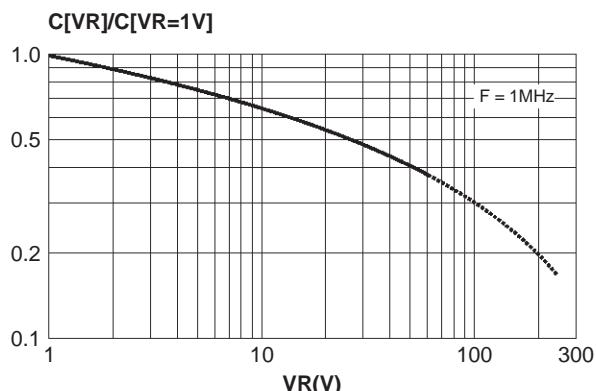


Fig. 5: Variation of thermal impedance junction to ambient versus pulse duration.

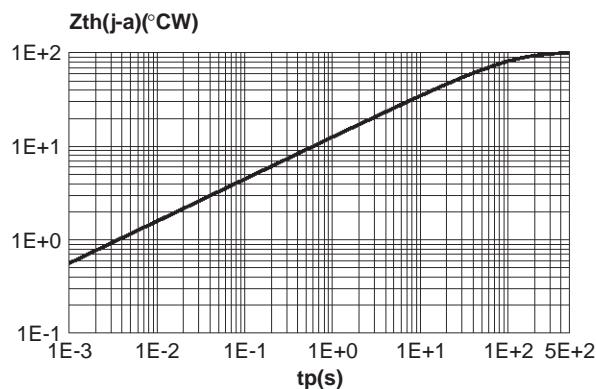


Fig. 2: Relative variation of holding current versus junction temperature.

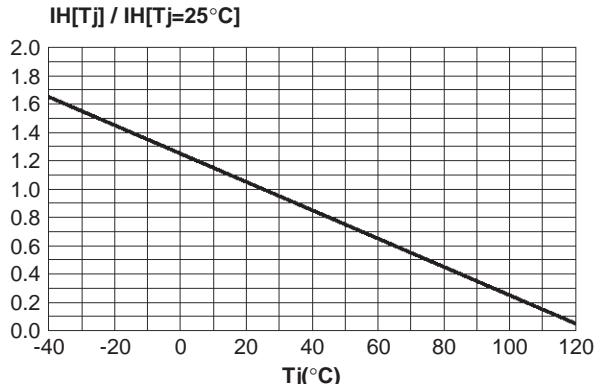


Fig. 4: On-state voltage versus on-state current (typical values).

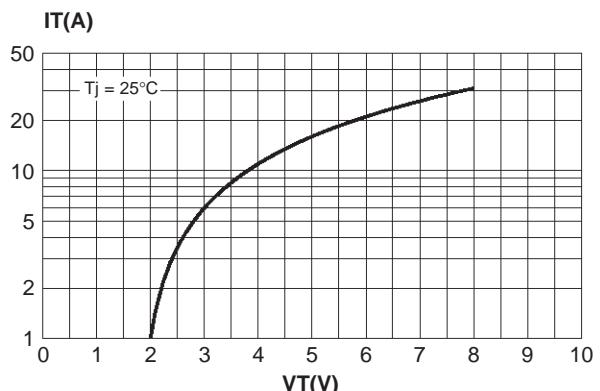
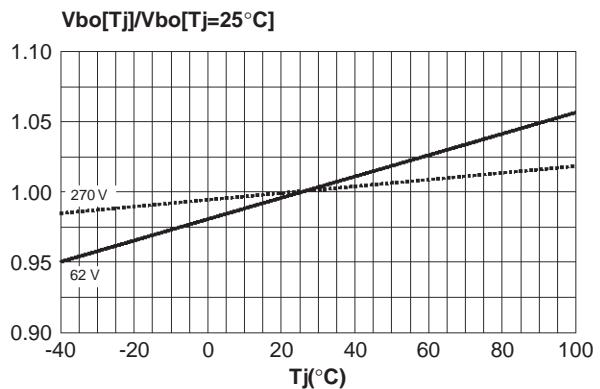
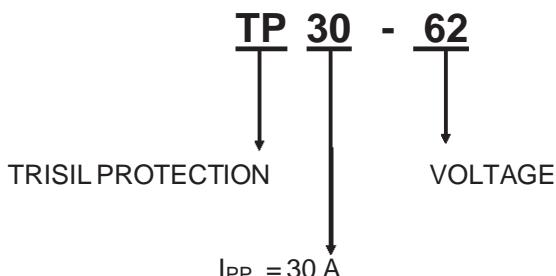


Fig. 6: Relative variation of V_{BO} voltage versus junction temperature.



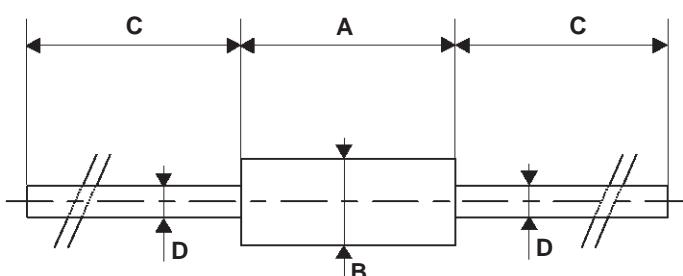
TP30-xxx Series

ORDER CODE



MARKING : Logo, Date Code, Part Number.

PACKAGE MECHANICAL DATA F126 (Plastic) (JEDEC DO-204AC)



| REF. | DIMENSIONS | | | | | |
|------|-------------|------|------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 6.05 | 6.20 | 6.35 | 0.238 | 0.244 | 0.250 |
| B | 2.95 | 3.00 | 3.05 | 0.116 | 0.118 | 0.120 |
| C | 26 | | 31 | 1.024 | | 1.220 |
| D | 0.76 | 0.81 | 0.86 | 0.030 | 0.032 | 0.034 |

Packaging : Tape and reel.

Weight : 0.40g

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